

Taiwanese IC Packaging & Testing Industry, 2Q 2021

<https://marketpublishers.com/r/TCD596200CDEN.html>

Date: June 2021

Pages: 16

Price: US\$ 1,000.00 (Single User License)

ID: TCD596200CDEN

Abstracts

The report finds that shipment value of the Taiwanese IC packaging and testing industry, or OSAT (Outsourced Semiconductor Assembly and Testing) reached US\$4.9 billion in the first quarter of 2021 and registered over 3.2% sequential and 17.2% year-on-year growth. The Taiwanese industry's growth in the first half of 2020 performed better than the same period of 2019, mainly attributed to order transfer of IDMs (Integrated Device Manufacturers) amid lockdowns worldwide. Owing to 5G commercialization, home economy due to COVID-19, and new smartphone and game console rollouts, the industry reached US\$18 billion and enjoyed over 16% year-on-year growth in 2020, up from US\$15.5 billion in 2019. Catering to the customers' continued demand for notebook PCs and displays, the industry is anticipated to have witnessed 5.7% sequential and 18.6% year-on-year growth in the second quarter of 2021.

Contents

Taiwanese IC Packaging and Testing Industry Shipment Value, 1Q 2019 - 3Q 2021

Taiwanese IC Packaging and Testing Industry Shipment Value by Service Type, 1Q 2019 - 3Q 2021

Taiwanese IC Packaging Industry Shipment Value, 1Q 2019 - 3Q 2021

Taiwanese IC Testing Industry Shipment Value, 1Q 2019 - 3Q 2021

Taiwanese IC Packaging Industry Shipment Value Rankings, 1Q 2019 - 1Q 2021

Taiwanese IC Packaging Industry Shipment Value by Vendor Tier, 1Q 2019 - 1Q 2021

Taiwanese IC Testing Industry's Shipment Value Rankings, 1Q 2019 - 1Q 2021

Taiwanese IC Testing Industry Shipment Value by Vendors' Tier, 1Q 2019 - 1Q 2021

Taiwanese IC Packaging Industry Shipment Value by Customer Origin, 1Q 2019 - 1Q 2021

Taiwanese IC Packaging Industry Shipment Value Share by Customer Origin, 1Q 2019 - 1Q 2021

Taiwanese IC Testing Industry Shipment Value by Customer Origin, 1Q 2019 - 1Q 2021

Taiwanese IC Testing Industry Shipment Value Share by Customer Origin, 1Q 2019 - 1Q 2021

Exchange Rate, 1Q 2019 - 1Q 2021

Research Scope & Definitions

I would like to order

Product name: Taiwanese IC Packaging & Testing Industry, 2Q 2021

Product link: <https://marketpublishers.com/r/TCD596200CDEN.html>

Price: US\$ 1,000.00 (Single User License / Electronic Delivery)

If you want to order Corporate License or Hard Copy, please, contact our Customer Service:

info@marketpublishers.com

Payment

To pay by Credit Card (Visa, MasterCard, American Express, PayPal), please, click button on product page <https://marketpublishers.com/r/TCD596200CDEN.html>

To pay by Wire Transfer, please, fill in your contact details in the form below:

First name:
Last name:
Email:
Company:
Address:
City:
Zip code:
Country:
Tel:
Fax:
Your message:

****All fields are required**

Customer signature _____

Please, note that by ordering from marketpublishers.com you are agreeing to our Terms & Conditions at <https://marketpublishers.com/docs/terms.html>

To place an order via fax simply print this form, fill in the information below and fax the completed form to +44 20 7900 3970